



NOTES:

1. ELECTRICAL CHARACTERISTICS :
 Current rating: 1 A Max.
 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 Contact resistance: 50 mΩ Max.
 Insulation resistance: 100 M
 Total mating force: 3.57 Kgf Max.
 Total unmating force: 0.71 Kgf Min.
 Temperature range: -0°C~50°C
2. MATERIALS :
 Material:
 Housing: P.B.T STANDARD COLOR-BLACK
 Shell: SPCC, PLATED WITH NICKEL
 Contact: Copper Alloy,
 PLATED WITH 30u" GOLD
3. UNSPECIFIED TOLERANCE: .XXX±0.130
 .XX ±0.25
 .X ±0.3

RoHS Compliant

		CONNECTING THE INFORMATION AGE	
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THIS DRAWING IS A CONTROLLED DOCUMENT.		G/NO:	
TITLE: MINI-USB B 5P Molding Solder		DWG NO: XUSB-7-4-5-3-6-1-03	
PART NO: XUSB-7-4-5-3-6-1-03		DRAWN: AUSTIN	
		UNIT mm[inch]	SHEET 1 of 1
		REV 01	DATE: Jan.12.06